# CUI DEVICES

### MODEL: HSS15-B20-P40 | DESCRIPTION: HEAT SINK

#### FEATURES

- TO-220 package
- solder pin
- aluminum alloy
- black anodized finish



MODEL	thermal resistance <sup>1</sup>				power dissipation <sup>1</sup>
	@ <b>75°C</b> ∆ <b>T,</b> nat conv (°C/W)	@ 1 W, nat conv (°C/W)	@ 1 W, 200 LFM (°C/W)	@ 1 W, 400 LFM (°C/W)	@ 75°C ΔT, nat conv (W)
HSS15-B20-P40	15.16	18.6	8.5	6.2	4.95

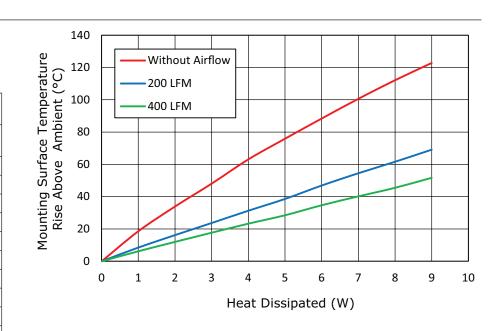
Note: 1. See performance curves for full thermal resistance details.

#### **PERFORMANCE CURVES**

	Heatsink Temperature Rise Above Ambient ( $\Delta T$ = Ths - Ta) (°C)			
Power (W)	Natural Conv.	200 LFM	400 LFM	
0	0	0	0	
1	18.6	8.5	6.2	
2	33.9	16.2	12.0	
3	48.1	23.7	17.7	
4	63.1	31.3	23.3	
5	75.9	38.6	28.5	
6	88.4	46.9	34.7	
7	100.6	54.5	40.2	
8	112.1	61.6	45.5	
9	122.8	69.1	51.7	

Ths: "hot spot" temperature measured on the heatsink Ta: ambient temperature

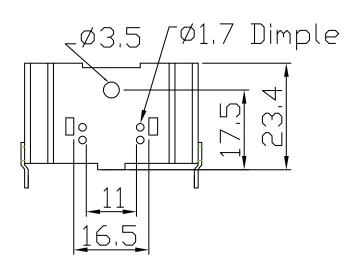
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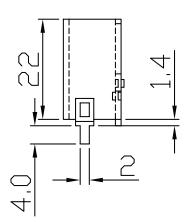


#### **MECHANICAL DRAWING**

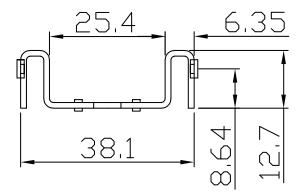
units: mm tolerance: ±0.3 mm

MATERIAL	AL 1050
FINISH	black anodized
THICKNESS	1.2 mm
PIN MATERIAL	copper alloy
PIN PLATING	2~3 µm tin
WEIGHT	1.6 g





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#### **REVISION HISTORY**

rev.	description	date
1.0	initial release	06/25/2021

The revision history provided is for informational purposes only and is believed to be accurate.

## **CUI** DEVICES

CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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